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COMPLEMENTARY PAIR ENHANCEMENT MODE MOSFET

Product Summary

Device	$V_{(BR)DSS}$	R _{DS(ON)}	I _D T _A = +25°C
Q1	25V	4Ω @ V _{GS} = 4.5V	0.4 A
00	201/	80mΩ @ V _{GS} = -12V	-3.2 A
Q2	-30V	125mΩ @ V _{GS} = -4.5V	-2.6 A

Description

This new generation MOSFET is designed to minimize the on-state resistance ($R_{DS(ON)}$) and yet maintain superior switching performance, making it ideal for high efficiency power management applications.

Applications

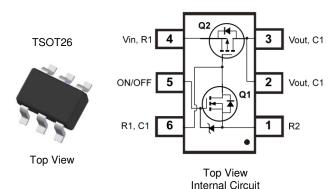
- DC-DC Converters
- Power Management Functions
- Load Switch

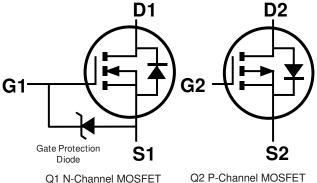
Features and Benefits

- Low On-Resistance
- Low Input Capacitance
- Fast Switching Speed
- Low Input/Output Leakage
- ESD Protected Gate on N-Channel (>6kV Human Body Model)
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- Qualified to AEC-Q101 Standards for High Reliability

Mechanical Data

- Case: TSOT26
- Case Material: Molded Plastic, "Green" Molding Compound.
 UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals Connections: See Diagram
- Terminals: Finish Matte Tin Annealed over Copper Leadframe. Solderable per MIL-STD-202, Method 208 @3
- Weight: 0.013 grams (Approximate)





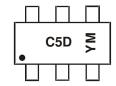
Ordering Information (Note 4)

Part Number	Case	Packaging
DMC25D0UVT-7	TSOT26	3000 / Tape & Reel
DMC25D0UVT-13	TSOT26	10000 / Tape & Reel

Notes:

- 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant.
- 2. See http://www.diodes.com/quality/lead_free.html for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- ${\it 4. For packaging details, go to our website at http://www.diodes.com/products/packages.html.}\\$

Marking Information



C5D = Product Type Marking Code YM or YM = Date Code Marking Y or Y= Year (ex: C = 2015) M = Month (ex: 9 = September)

Date Code Key

Year	201	5	2016		2017	20	18	2019		2020	2	2021
Code	С		D		Е		F	G		Н		
Month	Jan	Feb	Mar	Apr	May	Jun	Jul	Aug	Sep	Oct	Nov	Dec
Code	1	2	3	4	5	6	7	8	9	0	N	D



Maximum Ratings – Q1 (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit
Drain-Source Voltage	V_{DSS}	25	V
Gate-Source Voltage	V _{GSS}	-0.5 +8	V
Continuous Drain Current (Note 5) V _{GS} = 4.5V	I _D	0.4	Α
Maximum Continuous Body Diode Forward Current (Note 6)	Is	1.2	Α
Pulsed Drain Current (Note 6)	I _{DM}	1.5	A

Maximum Ratings – Q2 (@ $T_A = +25$ °C, unless otherwise specified.)

Characteristic		Symbol	Value	Unit
Drain-Source Voltage		V_{DSS}	-30	V
Gate-Source Voltage		V _{GSS}	±12	V
Continuous Drain Current (Note E) V 10V	Steady State		-3.2	Α
Continuous Drain Current (Note 5) V _{GS} = -10V	I _D	-14.4	Α	
Continuous Drain Current (Note 5) V _{GS} = -4.5V		-2.6	Α	
Maximum Continuous Body Diode Forward Current (Note 6)	I _S	-1.2	Α	
Pulsed Drain Current (Note 6)		I _{DM}	-20	Α

Thermal Characteristics

Characteristic	Symbol	Value	Unit		
Power Dissipation (Note 5)		P_{D}	1.2	W	
Thermal Resistance, Junction to Ambient (Note 5)	Steady State	D	101	°C/W	
Thermal nesistance, Junction to Ambient (Note 5)	$R_{\theta JA}$	5	C/VV		
Thermal Resistance, Junction to Case (Note 5)	$R_{ heta JC}$	37	°C/W		
Operating and Storage Temperature Range	T_{J}, T_{STG}	-55 to +150	°C		

Electrical Characteristics - Q1 (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition
OFF CHARACTERISTICS (Note 7)						
Drain-Source Breakdown Voltage	BV_{DSS}	25	_	_	V	$V_{GS} = 0V, I_D = 250\mu A$
Zero Gate Voltage Drain Current	IDSS	_	1	1	μΑ	$V_{DS} = 20V$, $V_{GS} = 0V$
Gate-Source Leakage	I _{GSS}	_	l	100	nA	$V_{GS} = 8V$, $V_{DS} = 0V$
ON CHARACTERISTICS (Note 7)						
Gate Threshold Voltage	V _{GS(TH)}	0.65	0.85	1.5	V	$V_{DS} = V_{GS}$, $I_D = 250\mu A$
Static Drain-Source On-Resistance	R _{DS(ON)}	_	3.8	4	Ω	$V_{GS} = 4.5V, I_D = 0.4A$
Diode Forward Voltage	V_{SD}	_	0.76	1.2	V	$V_{GS} = 0V, I_S = 0.29A$
DYNAMIC CHARACTERISTICS (Note 8)						
Input Capacitance	Ciss	_	26.2	_		$V_{DS} = 10V$, $V_{GS} = 0V$, $f = 1.0MHz$
Output Capacitance	Coss	_	7.1	_	pF	
Reverse Transfer Capacitance	C _{rss}	_	2.7	_		
Gate Resistance	R_g	_	84.5	_	Ω	$V_{DS} = 0V$, $V_{GS} = 0V$, $f = 1MHz$
Total Gate Charge (V _{GS} = 4.5V)	Q_g	_	0.4	_		
Total Gate Charge (V _{GS} = 8V)	Q_g	_	0.7	_	nC	V _{DS} = 5V. I _D = 0.2A
Gate-Source Charge	Q_{gs}	_	0.1	_	110	VDS = 5V, ID = 0.2A
Gate-Drain Charge	Q_{gd}	_	0.1	_		
Turn-On Delay Time	t _{D(ON)}	_	3	_		
Turn-On Rise Time	t _R	_	2.3	_	ns	$V_{GS} = 4.5V, V_{DS} = 6V,$
Turn-Off Delay Time	t _{D(OFF)}	_	7.7	_	IIS	$R_G = 50\Omega$, $I_D = 0.5A$
Turn-Off Fall Time	t _F	_	3.7	_		

- 5. Device mounted on FR-4 substrate PC board, 2oz copper, with 1inch square copper plate.
- 6. Repetitive rating, pulse width limited by junction temperature. 7. Short duration pulse test used to minimize self-heating effect.
- 8. Guaranteed by design. Not subject to production testing.

 9. Pulse Test: Pulse Width < 300µs, Duty Cycle < 2.0%.



Electrical Characteristics – Q2 (@T_A = +25°C, unless otherwise specified.)

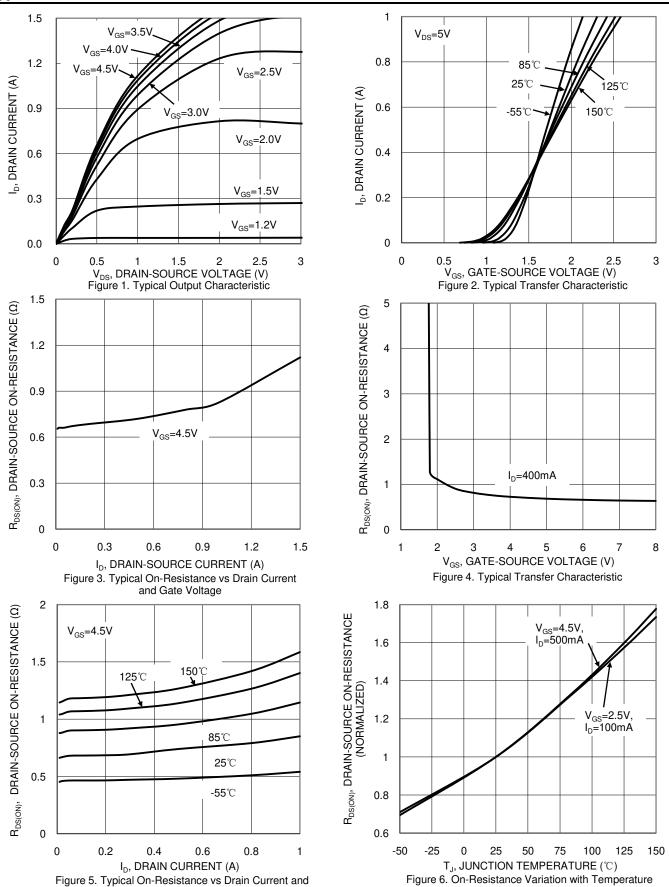
Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition
OFF CHARACTERISTICS (Note 10)				•		
Drain-Source Breakdown Voltage	BV _{DSS}	-30	_	_	V	$V_{GS} = 0V, I_D = -250\mu A$
Zero Gate Voltage Drain Current	I _{DSS}	_	_	-1	μΑ	$V_{DS} = -24V, V_{GS} = 0V$
Gate-Source Leakage	I _{GSS}	_	_	±100	nA	$V_{GS} = \pm 12V, V_{DS} = 0V$
ON CHARACTERISTICS (Note 10)				•		
Gate Threshold Voltage	V _{GS(TH)}	-0.5	-0.9	-1.5	V	$V_{DS} = V_{GS}, I_{D} = -250 \mu A$
		_	59	80		$V_{GS} = -12V, I_D = -2.3A$
Static Drain-Source On-Resistance	R _{DS(ON)}	_	75	125	mΩ	$V_{GS} = -4.5V, I_D = -1.9A$
	,	_	_	300		V _{GS} = -2.5V, I _D = -1A
Diode Forward Voltage	V _{SD}	_	-0.7	-1.2	V	$V_{GS} = 0V, I_{S} = -1A$
DYNAMIC CHARACTERISTICS (Note 11)				•		
Input Capacitance	C _{iss}		854			
Output Capacitance	Coss	_	53	_	pF	$V_{DS} = -15V, V_{GS} = 0V,$ f = 1MHz
Reverse Transfer Capacitance	C _{rss}	_	47	_		I = IIVIMZ
Gate Resistance	Rq	_	11	_	Ω	$V_{DS} = 0V$, $V_{GS} = 0V$, $f = 1MHz$
Total Gate Charge (V _{GS} = -4.5V)	Qg	_	10	_		
Total Gate Charge (V _{GS} = -10V)	Qq	_	21	_		15)/ 1
Gate-Source Charge	Q _{gs}	_	1.5	_	nC	$V_{DS} = -15V, I_{D} = -4A$
Gate-Drain Charge	Q _{qd}	_	2.8	_		
Turn-On Delay Time	t _{D(ON)}	-	3.5	_		
Turn-On Rise Time	t _R	-	3.3	_		$V_{GS} = -10V, V_{DS} = -15V,$
Turn-Off Delay Time	t _{D(OFF)}	_	61.4	_	ns	$R_G = 6\Omega$, $I_D = -1A$
Turn-Off Fall Time	t _F	_	14.6	_		

Notes:

- Short duration pulse test used to minimize self-heating effect.
 Guaranteed by design. Not subject to production testing.

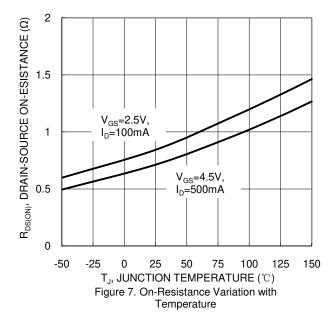


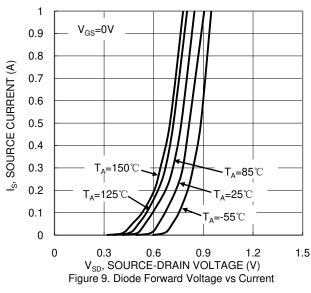
Typical Characteristics - N-CHANNEL

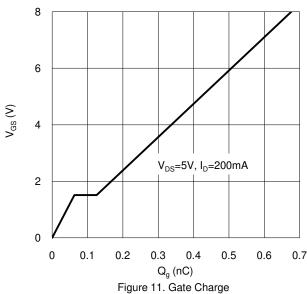


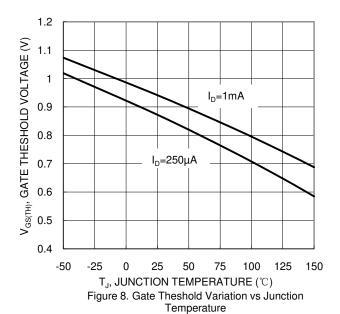
Temperature

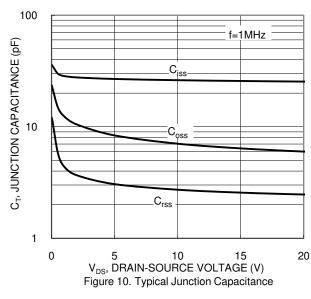


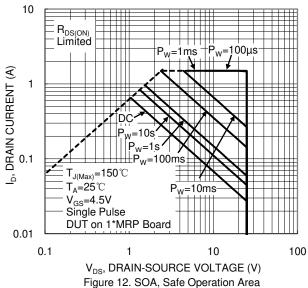




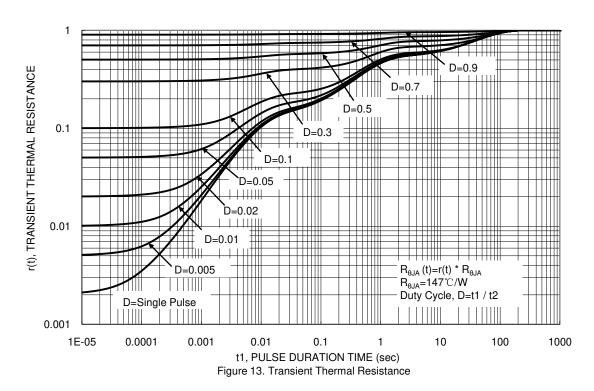






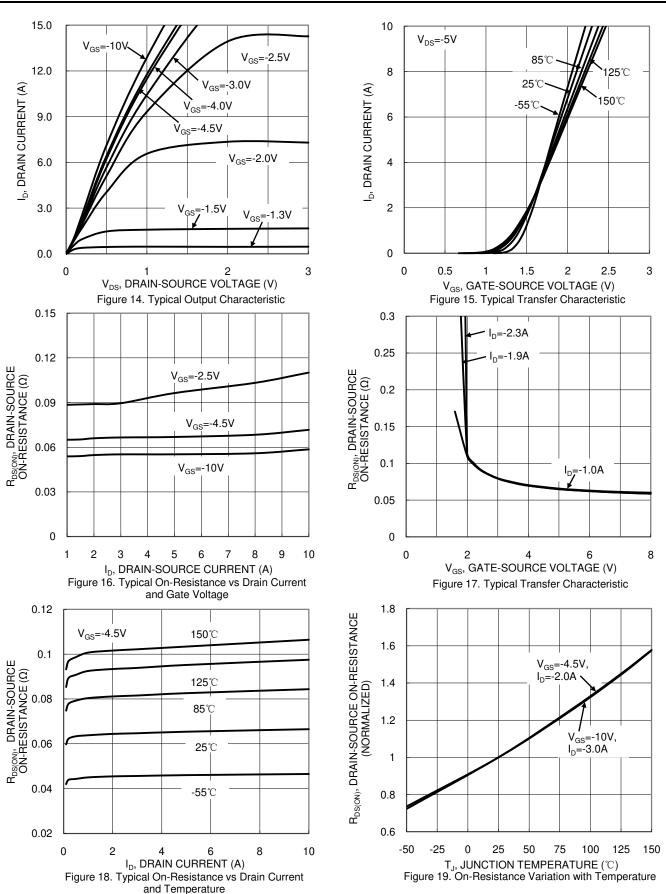




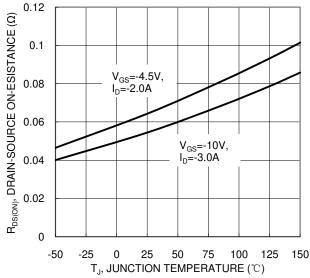


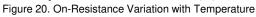


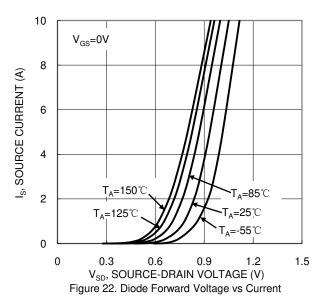
Typical Characteristics - P-CHANNEL

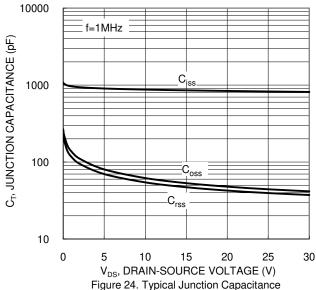


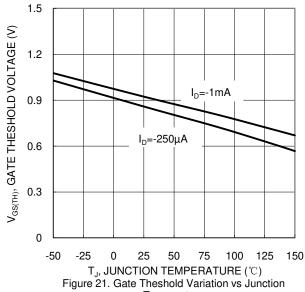




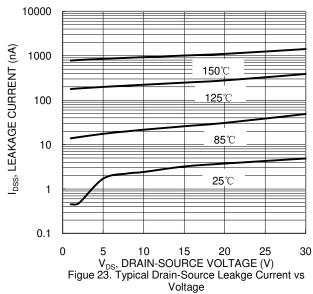






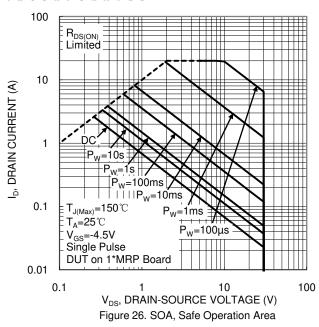


Temperature

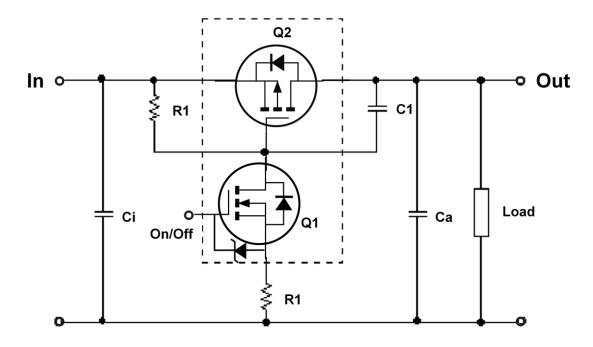


10 8 6 $V_{GS}(V)$ 4 V_{DS} =-15V, I_{D} =-4A 2 0 0 2 4 6 10 12 14 16 18 20 22 Q_g (nC) Figure 25. Gate Charge





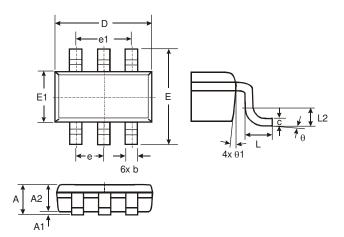
Application Circuit





Package Outline Dimensions

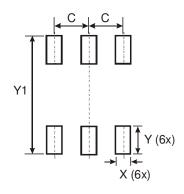
Please see AP02002 at http://www.diodes.com/datasheets/ap02002.pdf for the latest version.



	TSOT26						
Dim	Min	Max	Тур				
Α	_	1.00	-				
A 1	0.01	0.10	-				
A2	0.84	0.90	_				
D	-	-	2.90				
Е	_	-	2.80				
E1	_	-	1.60				
b	0.30	0.45	_				
С	0.12	0.20	_				
е	_	-	0.95				
e1	_	-	1.90				
L	0.30	0.50					
L2	_	_	0.25				
θ	0°	8°	4°				
θ1	4°	12°	_				
All D	All Dimensions in mm						

Suggested Pad Layout

Please see AP02001 at http://www.diodes.com/datasheets/ap02001.pdf for the latest version.



Dimensions	Value (in mm)
С	0.950
Х	0.700
Υ	1.000
Y1	3.199



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